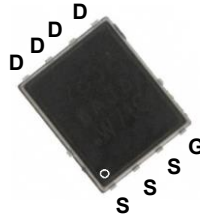
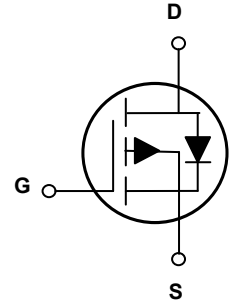


Main Product Characteristics

$V_{(BR)DSS}$	-40V
$R_{DS(ON)}$	5.8m Ω
I_D	-85A



PPAK5X6



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The SSFP4959A utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	-40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ($T_C=25^\circ\text{C}$)	I_D	-85	A
Drain Current-Continuous ($T_C=100^\circ\text{C}$)		-53.7	
Drain Current-Pulsed ¹	I_{DM}	-340	A
Single Pulse Avalanche Energy ²	E_{AS}	245	mJ
Single Pulse Avalanche Current ²	I_{AS}	-70	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	135	W
Power Dissipation-De-rate above 25 $^\circ\text{C}$		1.09	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.92	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	-50 To +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-50 To +150	$^\circ\text{C}$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On/Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-40	-	-	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=-1mA$	-	-0.03	-	$V/^{\circ}\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-40V, V_{GS}=0V,$ $T_J=25^{\circ}\text{C}$	-	-	-1	μA
		$V_{DS}=-32V, V_{GS}=0V,$ $T_J=125^{\circ}\text{C}$	-	-	-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-25A$	-	4.7	5.8	m Ω
		$V_{GS}=-4.5V, I_D=-12A$	-	6.4	8.5	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.2	-1.6	-2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		-	5.38	-	mV/ $^{\circ}\text{C}$
Forward Transconductance	g_{fs}	$V_{DS}=-10V, I_D=-3A$	-	15	-	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{3,4}	Q_g	$V_{DS}=-32V,$ $I_D=-10A,$ $V_{GS}=-10V$	-	106	160	nC
Gate-Source Charge ^{3,4}	Q_{gs}		-	13.1	20	
Gate-Drain Charge ^{3,4}	Q_{gd}		-	24.9	38	
Turn-On Delay Time ^{3,4}	$t_{d(on)}$	$V_{DD}=-32V, R_G=6\Omega,$ $V_{GS}=-10V, I_D=-1A$	-	41.6	82	nS
Rise Time ^{3,4}	t_r		-	12.7	26	
Turn-Off Delay Time ^{3,4}	$t_{d(off)}$		-	308	600	
Fall Time ^{3,4}	t_f		-	70	140	
Input Capacitance	C_{iss}	$V_{DS}=-25V,$ $V_{GS}=0V, F=1MHz$	-	5720	8580	pF
Output Capacitance	C_{oss}		-	527	790	
Reverse Transfer Capacitance	C_{rss}		-	352	528	
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V,$ $F=1MHz$	-	4.2	6.3	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0V,$ Force Current	-	-	-85	A
Pulsed Source Current	I_{SM}		-	-	-170	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-1A,$ $T_J=25^{\circ}\text{C}$	-	-	-1	V

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-70A, R_G=25\Omega,$ starting $T_J=25^{\circ}\text{C}$.
3. Pulse test: pulse width $\leq 300\mu s,$ duty cycle $\leq 2\%$.
4. Essentially independent of operation temperature.

Typical Electrical and Thermal Characteristic Curves

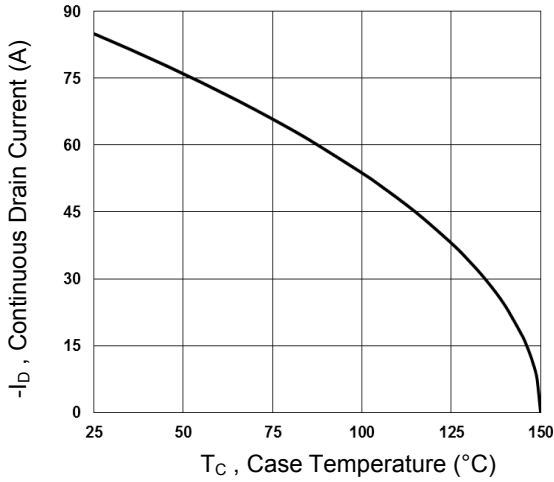


Figure 1. Continuous Drain Current vs. T_c

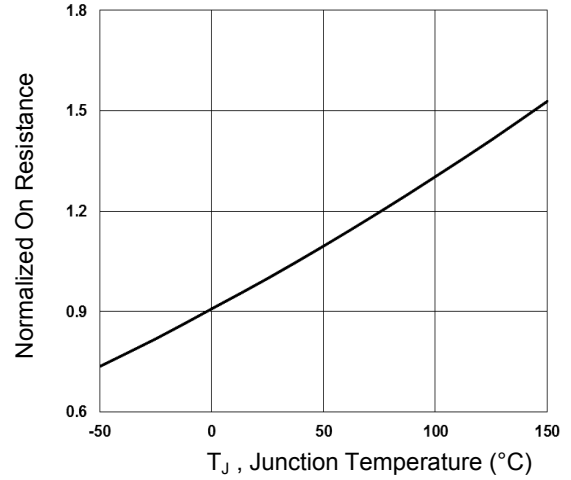


Figure 2. Normalized $R_{DS(ON)}$ vs. T_j

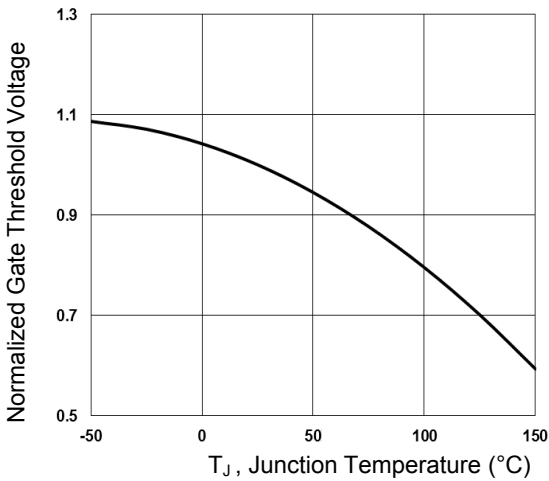


Figure 3. Normalized V_{th} vs. T_j

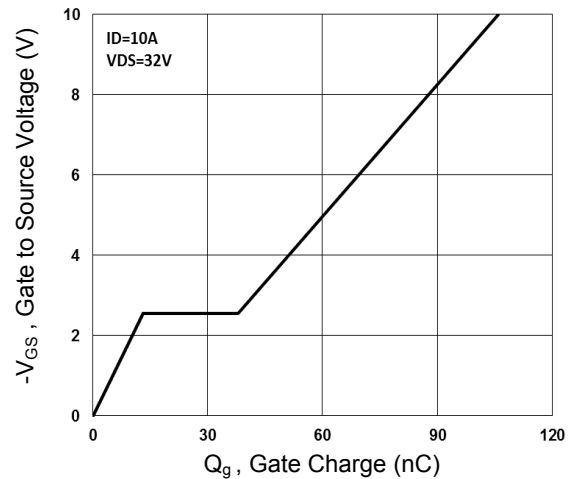


Figure 4. Gate Charge Waveform

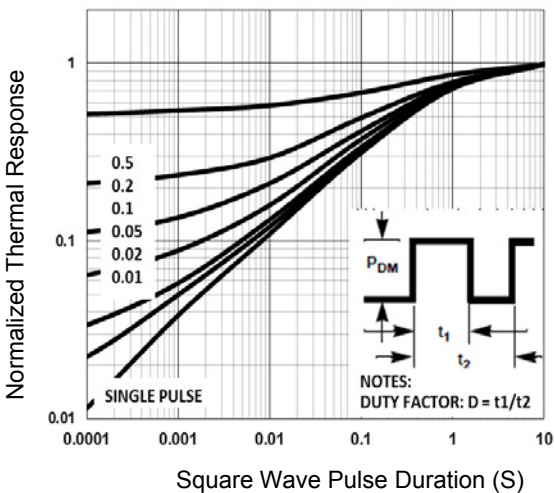


Figure 5. Normalized Transient Impedance

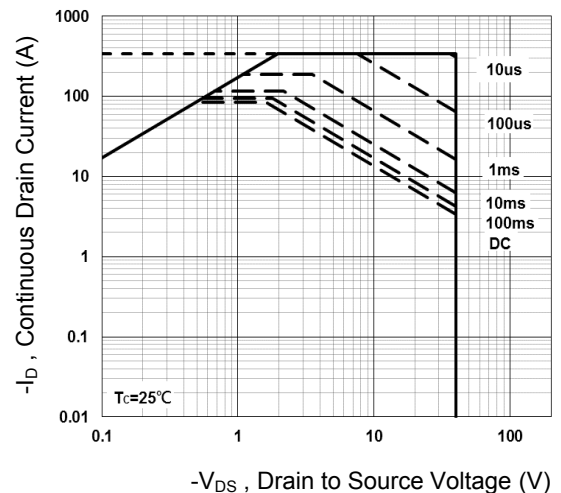


Figure 6. Maximum Safe Operation Area

Typical Electrical and Thermal Characteristic Curves

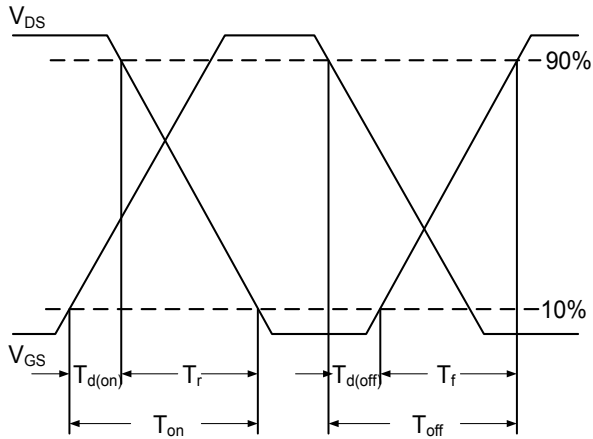


Figure 7. Switching Time Waveform

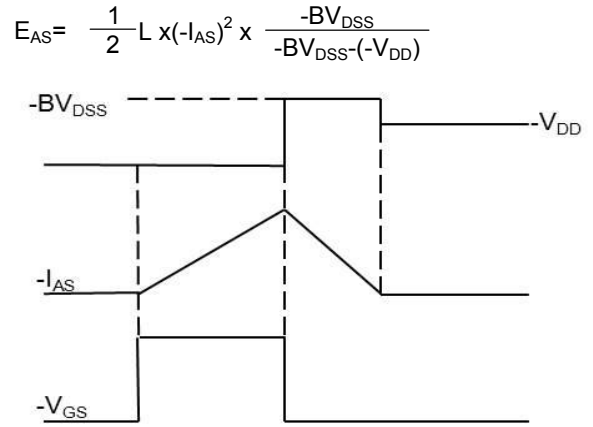
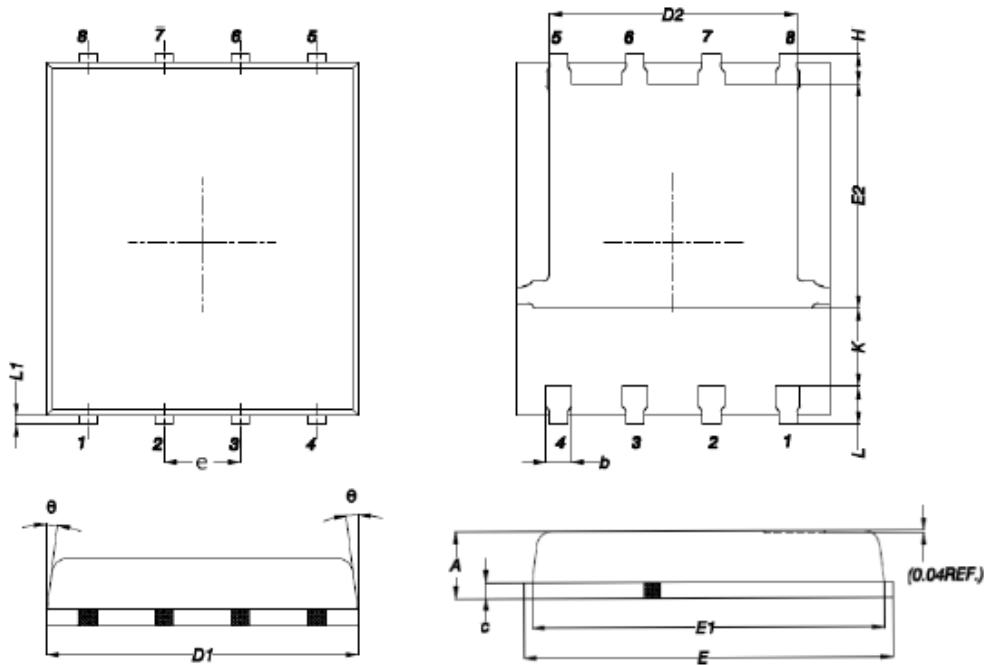


Figure 8. EAS Waveform

Package Outline Dimensions

PPAK5X6



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.200	0.850	0.047	0.031
b	0.510	0.300	0.020	0.012
C	0.300	0.200	0.012	0.008
D1	5.400	4.800	0.212	0.189
D2	4.310	3.610	0.170	0.142
E	6.300	5.850	0.248	0.230
E1	5.960	5.450	0.235	0.215
E2	3.920	3.300	0.154	0.130
e	1.27BSC		0.05BSC	
H	0.650	0.380	0.026	0.015
K	-	1.100	-	0.043
L	0.710	0.380	0.028	0.015
L1	0.250	0.050	0.009	0.002
θ	12°	0°	12°	0°

For more information, please contact us at: inquiry@goodarksemi.com